

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3997469

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DEZHEN CHEN	09/22/2014
XIAOBO MA	09/22/2014
LIJIE YIN	09/22/2014
LIN QIU	09/22/2014
RECEIVING PARTY DATA	
Name:	TONGJI UNIVERSITY
Street Address:	NO. 1239 SIPING ROAD
City:	SHANGHAI
State/Country:	CHINA
Postal Code:	200092
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14377828
CORRESPONDENCE DATA	
Fax Number:	(509)323-8979
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	509-324-9256
Email:	jenniferp@leehayes.com
Correspondent Name:	LEE & HAYES, PLLC
Address Line 1:	601 W. RIVERSIDE AVENUE
Address Line 2:	SUITE 1400
Address Line 4:	SPOKANE, WASHINGTON 99201
ATTORNEY DOCKET NUMBER:	S149-0003US
NAME OF SUBMITTER:	JENNIFER PHIPPS
SIGNATURE:	/Jennifer Phipps/
DATE SIGNED:	08/08/2016
Total Attachments: 3	
source=1JK7330#page1.tif	
source=1JK7330#page2.tif	

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial Number.....14/377,828
Filing Date 08/8/2014
Inventorship Chen et al.
Applicant Tongji University
Attorney's Docket No. S149-0003US
Client Docket No. CN291-11002PIUS
Title: System and Method for Hydrothermal Reaction

PATENT ASSIGNMENT

PARTIES TO THE ASSIGNMENT

Assignor(s):

Dezhen Chen
No. 1239 Siping Road
Shanghai 200092
CHINA

Xiaobo Ma
No. 1239 Siping Road
Shanghai 200092
CHINA

Lijie Yin
No. 1239 Siping Road
Shanghai 200092
CHINA

Lin Qiu
No. 600, Songze Avenue
Shanghai 201702
CHINA

Assignee:

Tongji University
No. 1239 Siping Road
Shanghai 201702
CHINA

AGREEMENT

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled "System and Method for Hydrothermal Reaction" for which:

☐ a provisional application for United States Letters Patent was filed on _____ and was given U.S. Serial No. _____ and/or

☒ a non-provisional application for United States Letters Patent was:

☒ filed on August 8, 2014 and was given U.S. Serial No. 14/377,828; or filed concurrently herewith. Assignors hereby authorize and request ASSIGNEE's legal representatives, of Lee & Hayes, PLLC, 601 W Riverside Ave, Suite 1400, Spokane, Washington 99201, who are associated with customer number 29150, to insert in the caption above the serial number and filing date of the patent application when known.

WHEREAS, **Tongji University** (hereinafter referred to as ASSIGNEE), having a place of business at No. 1239 Siping Road, Shanghai 200092, CHINA, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S)

had this assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNOR(S) agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

September 22, 2014
Date

Dezhen Chen
Dezhen Chen

September 22, 2014
Date

Xiaobo MA
Xiaobo Ma

September 22, 2014
Date

Lijie Yin
Lijie Yin

September 22, 2014
Date

Lin Qiu
Lin Qiu